



Remarks:

Claims 1-6 remain in the application. Claim 3 has been amended in order to more clearly define the invention of the instant application.

On page 12, line 4 of the specification, the text "metallization layer 5" has been inserted after the word "lead
9" in order to describe the invention more clearly.

The preliminary amendment is being filed in an effort to comply with the requirement that every feature in the claims should be shown in the drawings or otherwise should be deleted.

An earlier action on the merits is requested.

Respectfully submitted,

For Applicant

YHC:cgm

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Applic. No. MADE 1023, 189

Marked-Up Version of the Amended Paragraphs in the Specification and Marked-Up Version of the Amended Claims:

The paragraph starting on page 12, line 1 and ending on page 12, line 11 now reads as:

In the case of the switching element 6 adjacent alongside on the right, the current path is produced from top to bottom in exactly the reverse order: the second supply potential 12 at the load current connection element 10 - the lead 9 - the metallization layer 5 - the drain contact of the semiconductor switch 17 - the source contact of the semiconductor switch 17 - the bonding connection 16, the metallization layer 5 - the drain contact of the semiconductor switch 17' - the source contact of the semiconductor switch 17' - the lead 9 - the load current connection element 10, connected to the first supply potential 11 (reference-ground potential).

Claim 3 (amended). The semiconductor component according to claim 1, wherein each of said two switching elements contain two semiconductor switches connected in series [at a junction point, said junction point], each of said two semiconductor switches is connected to one of said external load current connection elements and forms an output of the semiconductor component.